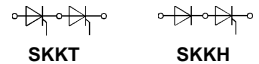


## SEMPACK® 0 Thyristor/ Diode Modules

### SKKT 15 SKKH 15



#### Features

- Heat transfer through aluminium oxide ceramic isolated metal baseplate
- Hard soldered joints for high reliability
- UL recognized, file no. E 63 532

#### Typical Applications

- DC motor control (e. g. for machine tools)
- Temperature control (e. g. for ovens, chemical processes)
- Professional light dimming (studios, theaters)

$V_{RSM}$	$V_{RRM}$ $V_{DRM}$	$(dv/dt)_{cr}$	$I_{TRMS}$ (maximum values for continuous operation)	
			$24 A^1$ ; $28 A^2$	$24 A^1$ ; $28 A^2$
V	V	V/ $\mu s$	$I_{TAV}$ (sin. 180; $T_{case} = 65^\circ C$ ) $17,5 A^2$	
500	400	500	<b>SKKT 15/04</b>	<b>SKKH 15/04</b>
700	600	500	<b>SKKT 15/06</b>	<b>SKKH 15/06</b>
900	800	500	<b>SKKT 15/08</b>	<b>SKKH 15/08</b>
1300	1200	500	<b>SKKT 15/12</b>	<b>SKKH 15/12</b>
1500	1400	500	<b>SKKT 15/14</b>	<b>SKKH 15/14</b>
1700	1600	500	<b>SKKT 15/16</b>	<b>SKKH 15/16</b>

Symbol	Conditions	SKKT 15 SKKH 15
$I_{TAV}$	sin. 180; $T_{case} = 65^\circ C$ $T_{case} = 75^\circ C$	$17,5 A^2$ $15 A^1$
$I_D$	B2/B6   $T_{amb} = 45^\circ C$ ; P 13A/100	14 A/17 A
$I_{RMS}$	W1/W3   $T_{amb} = 45^\circ C$ ; P 13A/100	21 A/3 x 12 A
$I_{TSM}$	$T_{vj} = 25^\circ C$ ; 10 ms $T_{vj} = 125^\circ C$ ; 10 ms	320 A 280 A
$i^2t$	$T_{vj} = 25^\circ C$ ; 8,3 ... 10 ms $T_{vj} = 125^\circ C$ ; 8,3 ... 10 ms	$510 A^2s$ $390 A^2s$
$t_{gd}$	$T_{vj} = 25^\circ C$ ; $I_G = 1 A$ ; $di_G/dt = 1 A/\mu s$	1 $\mu s$
$t_{gr}$	$V_D = 0,67 \cdot V_{DRM}$	1 $\mu s$
$(di/dt)_{cr}$	$T_{vj} = 125^\circ C$	100 A/ $\mu s$
$t_q$	$T_{vj} = 125^\circ C$	typ. 80 $\mu s$
$I_H$	$T_{vj} = 25^\circ C$ ; typ./max.	80 mA/150 mA
$I_L$	$T_{vj} = 25^\circ C$ ; $R_G = 33 \Omega$ ; typ./max.	150 mA/300 mA
$V_T$	$T_{vj} = 25^\circ C$ ; $I_T = 75 A$	max. 2,45 V
$V_{T(TO)}$	$T_{vj} = 125^\circ C$	1,1 V
$r_T$	$T_{vj} = 125^\circ C$	20 m $\Omega$
$I_{DD}$ ; $I_{RD}$	$T_{vj} = 125^\circ C$ ; $V_{DD} = V_{DRM}$ ; $V_{RD} = V_{RRM}$	max. 8 mA
$V_{GT}$	$T_{vj} = 25^\circ C$ ; d. c.	3 V
$I_{GT}$	$T_{vj} = 25^\circ C$ ; d. c.	100 mA
$V_{GD}$	$T_{vj} = 125^\circ C$ ; d. c.	0,25 V
$I_{GD}$	$T_{vj} = 125^\circ C$ ; d. c.	5 mA
$R_{thjc}$	cont. sin. 180 rec.120	} per thyristor/per module 1,6/0,8 °C/W 1,7/0,9 °C/W 1,8/0,9 °C/W 0,2/0,1 °C/W
$R_{thch}$		
$T_{vj}$		
$T_{stg}$		
$V_{isol}$	a. c. 50 Hz; r.m.s.; 1 s/1 min	3600 V~/3000 V~
$M_1$	Case to heatsink; SI units/US units	1,5 Nm/13 lb. in. $\pm 15\%^{3)}$
a		$5 \cdot 9,81 m/s^2$
w	approx.	50 g
Case	→ page B 1 – 30	SKKT 15: A1 SKKH 15: A2

<sup>1)</sup> Using tin plated connectors with flexible leads of 6 mm<sup>2</sup> for the main terminals

<sup>2)</sup> Flexible leads of 6 mm<sup>2</sup> soldered to the main terminals

<sup>3)</sup> See the assembly instructions

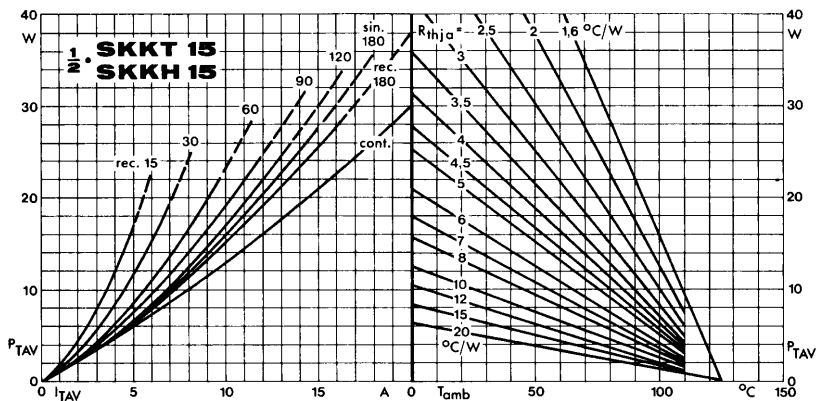


Fig. 1 Power dissipation per thyristor vs. on-state current and ambient temperature

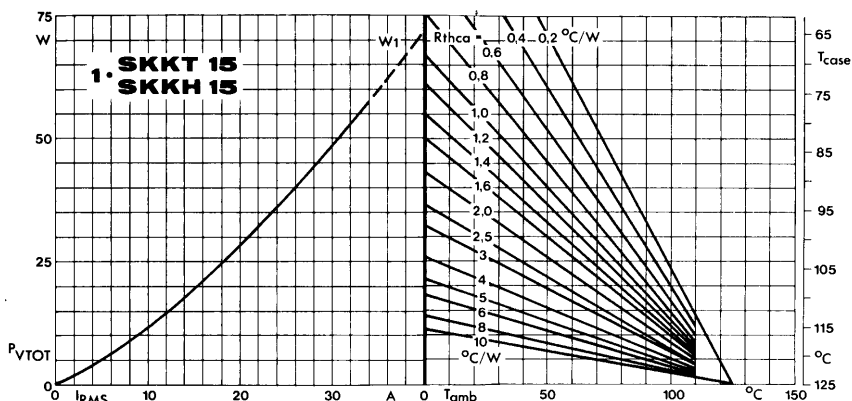


Fig. 2 Power dissipation per module vs. rms current and case temperature

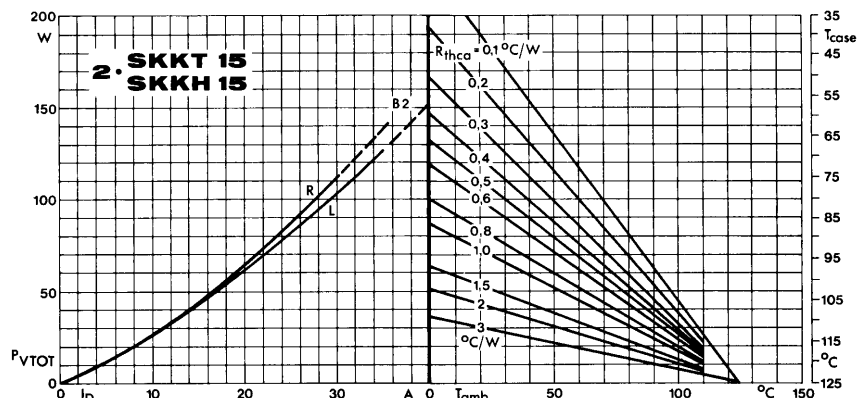


Fig. 3 Power dissipation of two modules vs. direct current and case temperature

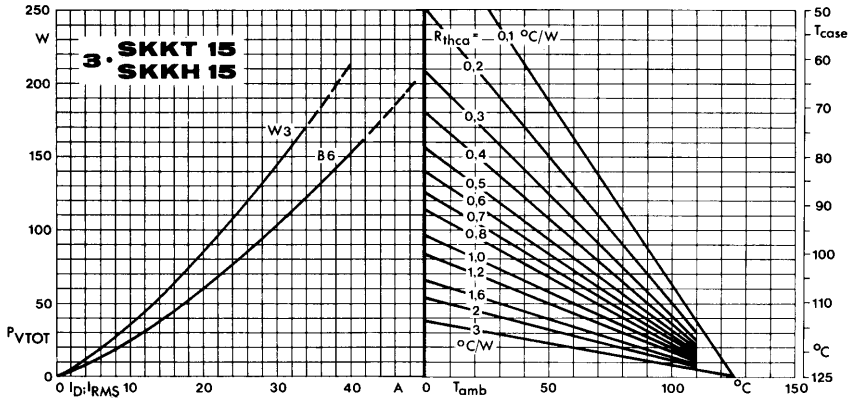


Fig. 4 Power dissipation of three modules vs. direct and rms current and case temperature

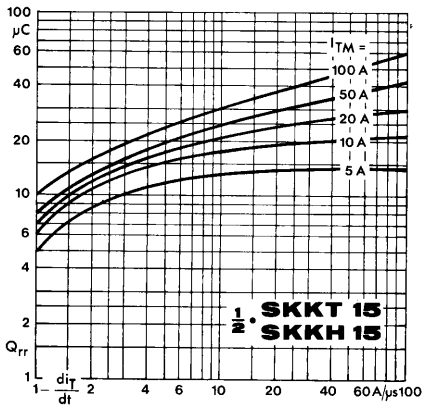


Fig. 5 Recovered charge vs. current decrease

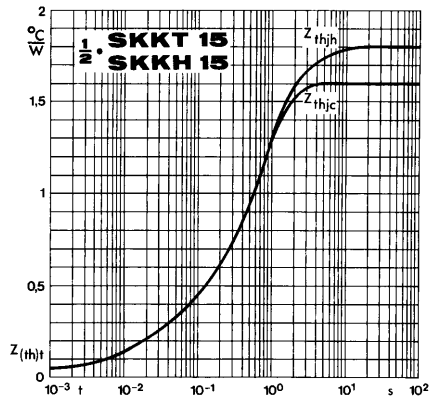


Fig. 6 Transient thermal impedance vs. time

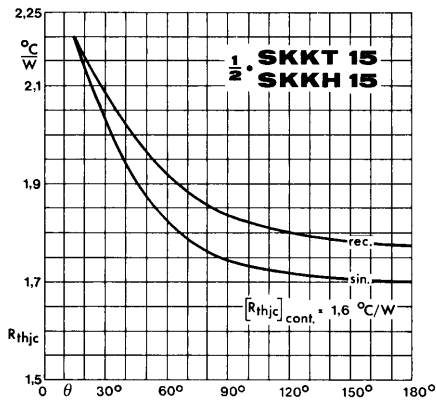


Fig. 7 Thermal resistance vs. conduction angle

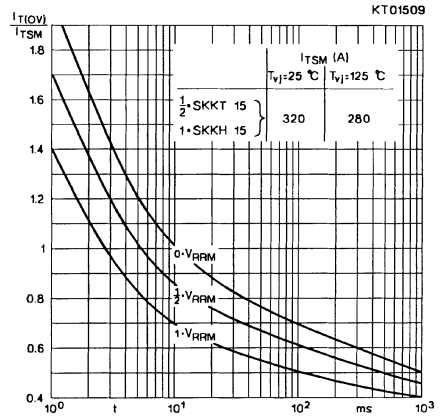
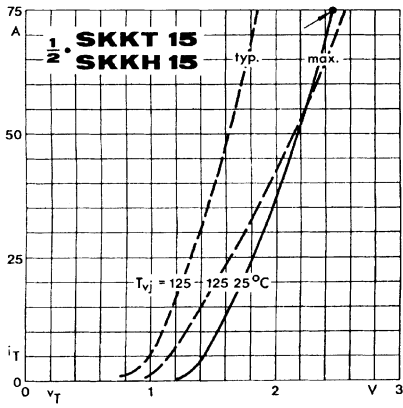


Fig. 8 On-state characteristics

Fig. 9 Surge overload current vs. time

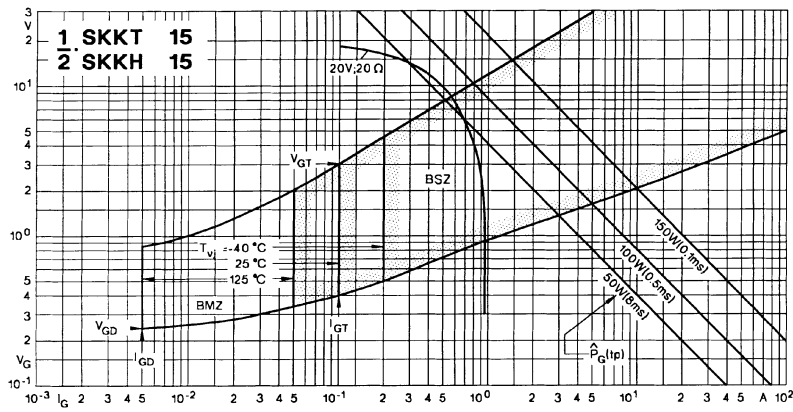


Fig. 10 Gate trigger characteristics

